

H7N0308CF

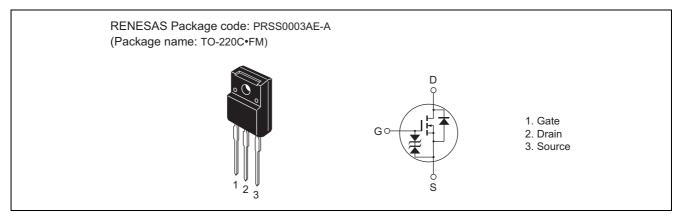
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1123-0300 (Previous: ADE-208-1570A) Rev.3.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS (on)} = 3.8 \text{ m}\Omega \text{ typ.}$
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	60	А
Drain peak current	I _{D (pulse)} Note 1	240	А
Body-drain diode reverse drain current	I _{DR}	60	А
Channel dissipation	Pch Note 2	30	W
Channel to case thermal impedance	θ ch-c	4.17	°C/W
Channel to ambient thermal impedance	θ ch-a	62.5	°C/W
Channel temperature	Tch	150	٥°
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

Electrical Characteristics

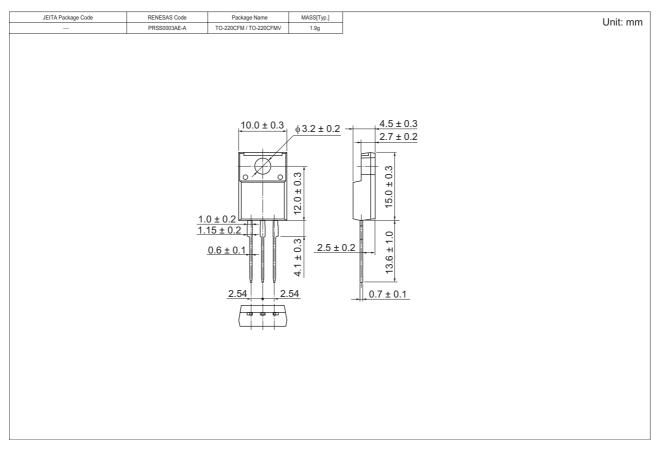
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—	_	V	$I_{G} = \pm 100 \ \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	10	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0	—	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{Note 3}$
Static drain to source on state resistance	R _{DS (on)}	—	3.8	4.8	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{Note 3}$
		—	6.0	8.5	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note 3}$
Forward transfer admittance	y _{fs}	42	70	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{Note 3}$
Input capacitance	Ciss	—	3350	_	pF	V _{DS} = 10 V
Output capacitance	Coss	—	840	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	480	_	pF	f = 1 MHz
Total gate charge	Qg	—	52	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	—	11	_	nC	V _{GS} = 10 V
Gate to drain charge	Qgd	—	10	_	nC	I _D = 60 A
Turn-on delay time	t _{d (on)}	—	30		ns	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$
Rise time	tr	—	370	_	ns	$R_L = 0.33 \Omega$
Turn-off delay time	t _{d (off)}	—	80		ns	Rg = 4.7 Ω
Fall time	t _f	—	27	_	ns	
Body-drain diode forward voltage	V _{DF}	—	0.90	_	V	$I_F = 60 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t _{rr}	—	55		ns	$I_F = 60 \text{ A}, V_{GS} = 0$
						di _F /dt = 50 A/µs

Note: 3. Pulse test

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Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container	
H7N0308CF-E	50 pcs	Plastic magazine	

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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